

/ Descriptions

TO-263

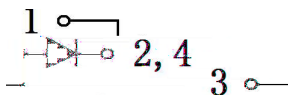
/ Features

/ Applications

DC-DC

OR-ing

/ Equivalent Circuit



/ Pinning



/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

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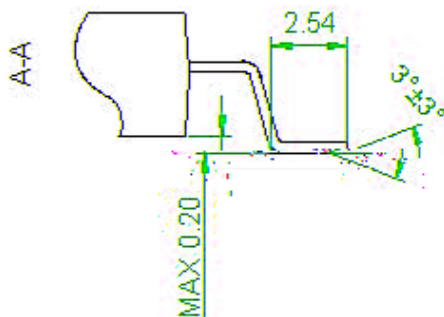
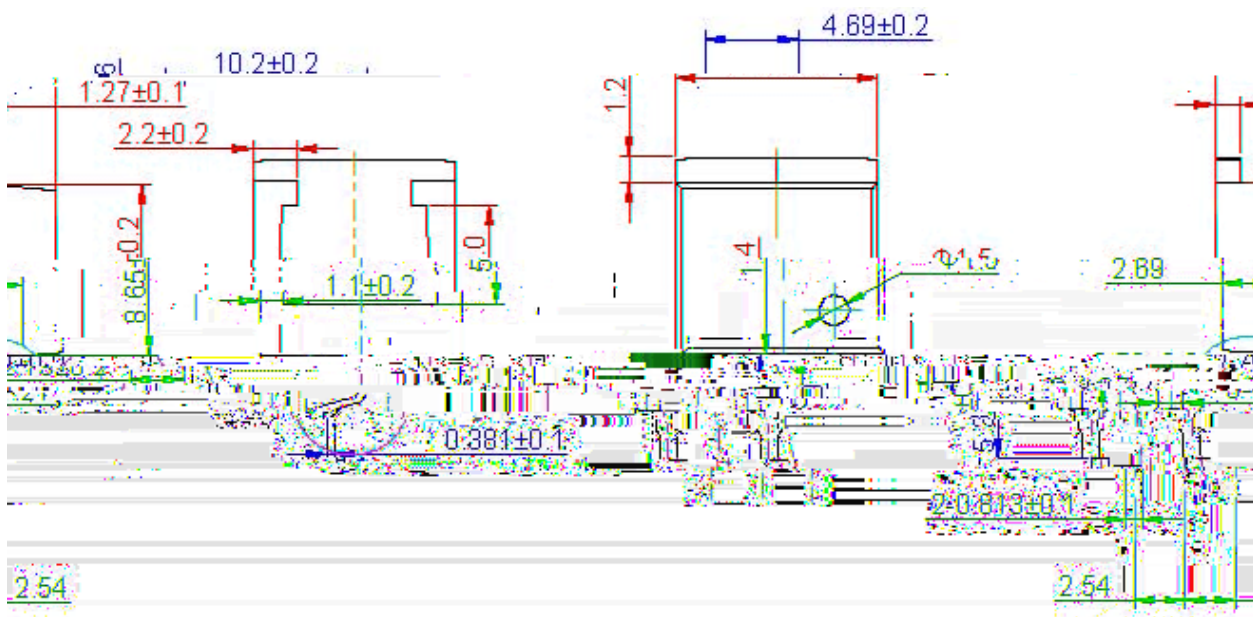
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/ Electrical Characteristics(Ta=25)

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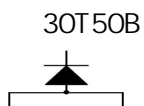
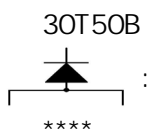
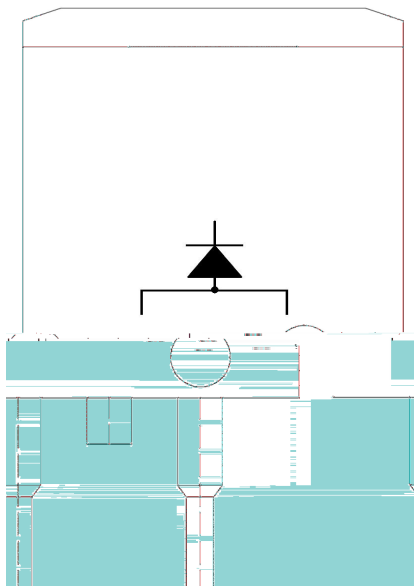
(3)

/ Package Dimensions

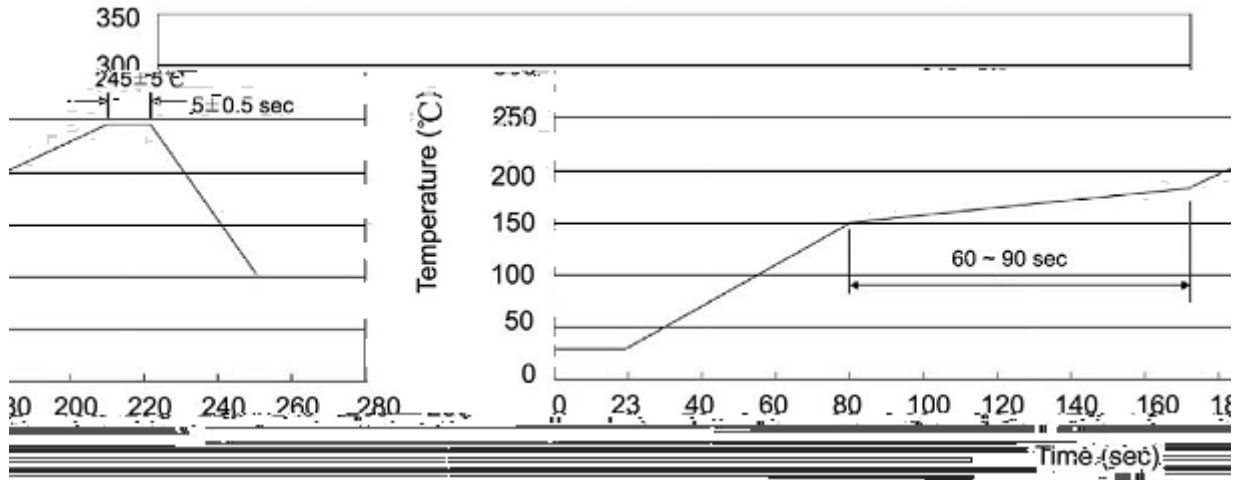


注：未注公差± ；未注 <

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

| 封装形式 | 包装数量 | | | | | 包装尺寸 : | | |
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| | 只 套管 | 套管 盒 | 只 盒 | 盒 箱 | 只 箱 | 套管 | 盒 | 箱 |
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| 封装形式 | 包装数量 | | | | | 包装尺寸 : | | |
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/ Notices